

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/281,735
Priority Filing Date March 30, 1999
 Inventor Eugene P. Marsh
 Assignee Micron Technology, Inc.
Priority Group Art Unit 2811
Priority Examiner H. Vu
 Attorney's Docket No. MI22-1284
 Title: Circuitry Comprising Roughened Platinum Layers, Platinum-Containing Materials, Capacitors Comprising Roughened Platinum Layers, Methods of Forming Roughened Layers of Platinum, and Methods of Forming Capacitors

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E. Hillis

11-22-99

PRELIMINARY AMENDMENT

To: Assistant Commissioner for Patents
Washington, D.C. 20231

From: David G. Latwesen (Tel. 509-624-4276; Fax 509-838-3424)
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AMENDMENTSIn the Specification

At p. 1, before the "Technical Field" section, insert ✓

RELATED PATENT DATA

This patent resulted from a continuation application of U.S. Patent Application Serial No. 09/281,735, which was filed on March 30, 1999, which is a divisional application of U.S. Patent Application Serial No. 09/141,840, which was filed on August 27, 1998.